Lonten N-channel 600V, 80A, 0.039Ω LonFET™ Power MOSFET

Description

LonFET™ Power MOSFET is fabricated using advanced super junction technology. The resulting device has extremely low on resistance, making it especially suitable for applications which require superior power density and outstanding efficiency.

Features

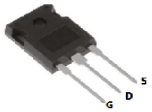
- Ultra low $R_{DS(on)}$
- Ultra low gate charge (typ. Q_g = 110nC)
- 100% UIS tested
- RoHS compliant

Applications

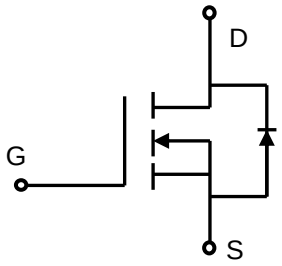
- Power faction correction (PFC).
- Switched mode power supplies (SMPS).
- Uninterruptible power supply (UPS).

Product Summary

V_{DS} @ $T_{j,max}$	650V
$R_{DS(on),max}$	0.039Ω
I_{DM}	240A
$Q_{g,typ}$	110nC



TO-247



N-Channel MOSFET

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	600	V
Continuous drain current (T_C = 25°C)	I_D	80	A
(T_C = 100°C)		52	A
Pulsed drain current [1]	I_{DM}	240	A
Gate-Source voltage	V_{GSS}	±30	V
Avalanche energy, single pulse [2]	E_{AS}	2350	mJ
Power Dissipation TO-247 (T_C = 25°C)	P_D	500	W
- Derate above 25°C		4.0	W/°C
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C
Continuous diode forward current	I_S	80	A
Diode pulse current	$I_{S,pulse}$	240	A

Thermal Characteristics TO-247

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.25	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	°C/W
Soldering temperature, wavesoldering only allowed at leads. (1.6mm from case for 10s)	T_{sold}	260	°C

Package Marking and Ordering Information

Device	Device Package	Marking	Units/Tube	Units/Real
LSB60R039GT	TO-247	LSB60R039GT	30	

Electrical Characteristics

T_c = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	V_{GS}=0 V, I_D=0.25 mA	600	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=0.25 mA	2.5	3.0	4.5	V
Drain cut-off current	I_{DSS}	V_{DS}=600 V, V_{GS}=0 V,				μA
		T_j = 25°C	-	-	1	
		T_j = 125°C	-	10	-	
Gate leakage current, Forward	I_{GSSF}	V_{GS}=30 V, V_{DS}=0 V	-	-	100	nA
Gate leakage current, Reverse	I_{GSSR}	V_{GS}=-30 V, V_{DS}=0 V	-	-	-100	nA
Drain-source on-state resistance	$R_{DS(on)}$	V_{GS}=10 V, I_D=40 A	-			
		T_j = 25°C	-	0.035	0.039	Ω
		T_j = 150°C	-	0.074	-	
Dynamic characteristics						
Input capacitance	C_{iss}	V_{DS} = 25 V, V_{GS} = 0 V,	-	6000	-	
Output capacitance	C_{oss}	f = 1 MHz	-	4800	-	pF
Reverse transfer capacitance	C_{rss}		-	35	-	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 400 V, I_D = 40 A	-	46	-	
Rise time	t_r	R_G = 10 Ω, V_{GS}=10 V	-	52	-	ns
Turn-off delay time	$t_{d(off)}$		-	342	-	
Fall time	t_f		-	8.6	-	
Gate charge characteristics						
Gate to source charge	Q_{gs}	V_{DD}=480 V, I_D=40 A,	-	25.7	-	
Gate to drain charge	Q_{gd}	V_{GS}=0 to 10 V	-	42.2	-	nC
Gate charge total	Q_g		-	110	-	
Gate plateau voltage	$V_{plateau}$		-	6.0	-	V
Reverse diode characteristics						
Diode forward voltage	V_{SD}	V_{GS}=0 V, I_F=40 A	-	-	1.2	V
Reverse recovery time	t_{rr}	V_R=50 V, I_F=40 A,	-	594	-	ns
Reverse recovery charge	Q_{rr}	dI_F/dt=100 A/μs	-	8.5	-	μC
Peak reverse recovery current	I_{rrm}		-	29	-	A

Notes:

1. Limited by maximum junction temperature, maximum duty cycle is 0.75.

2. I_{AS} = 10A, V_{DD} =60V, Starting T_j= 25°C.

Electrical Characteristics Diagrams

Figure 1. On-Region Characteristics

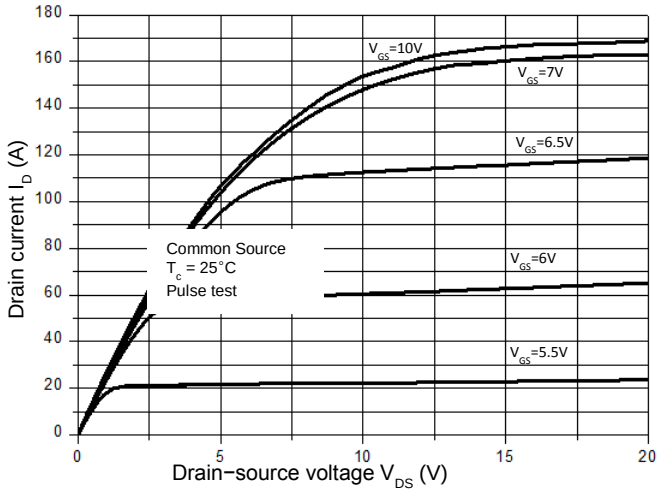


Figure 2. Transfer Characteristics

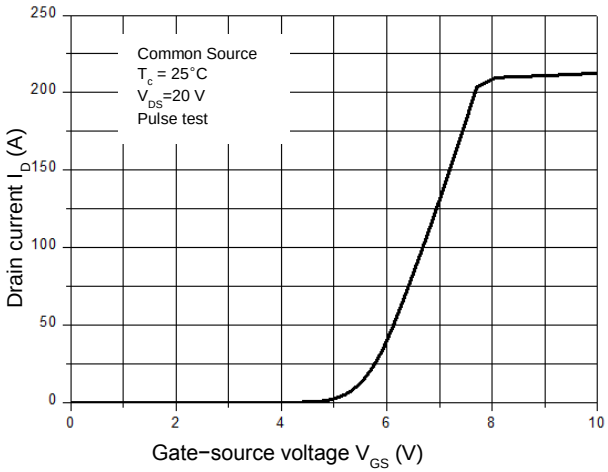


Figure 3. On-Resistance Variation vs. Drain Current

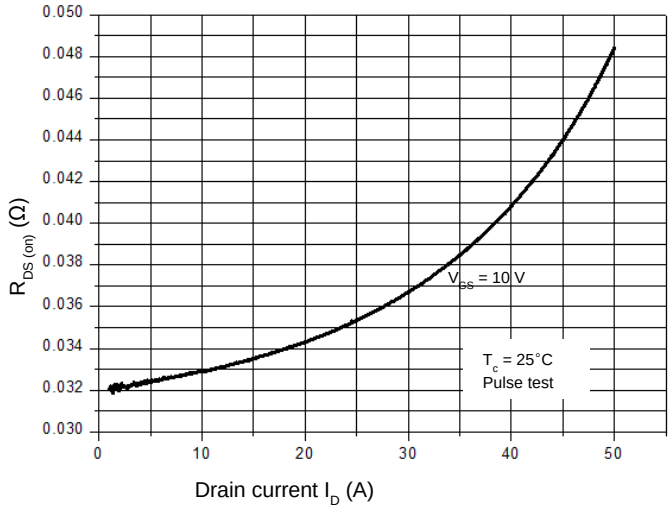


Figure 4. Threshold Voltage vs. Temperature

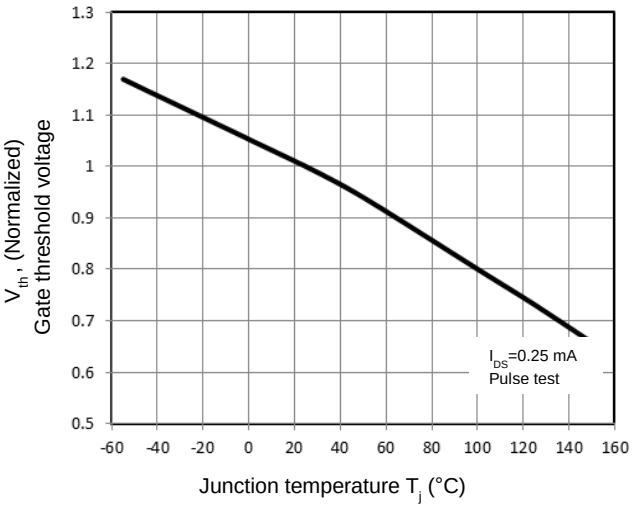


Figure 5. Breakdown Voltage vs. Temperature

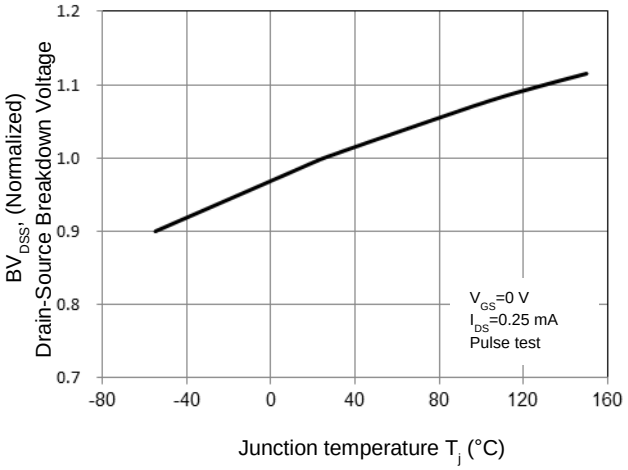


Figure 6. On-Resistance vs. Temperature

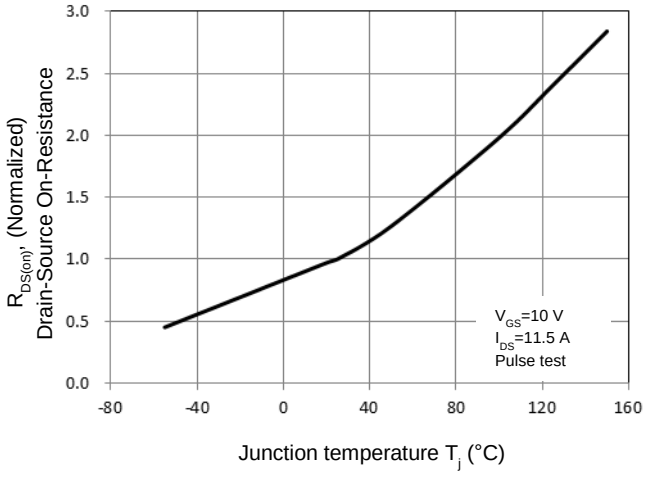


Figure 7. Capacitance Characteristics

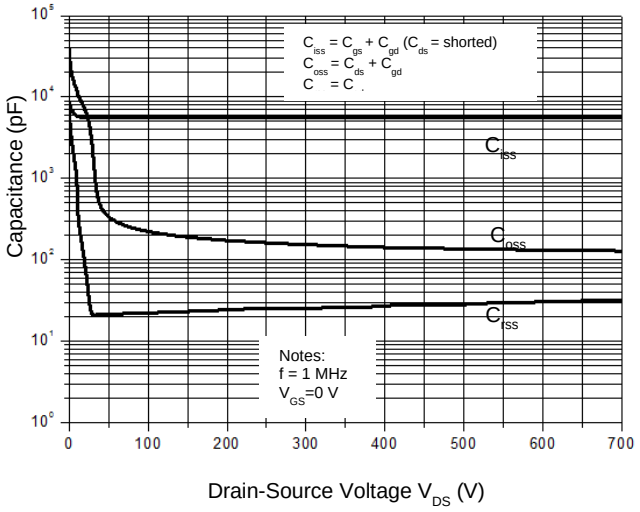


Figure 8. Gate Charge Characterist

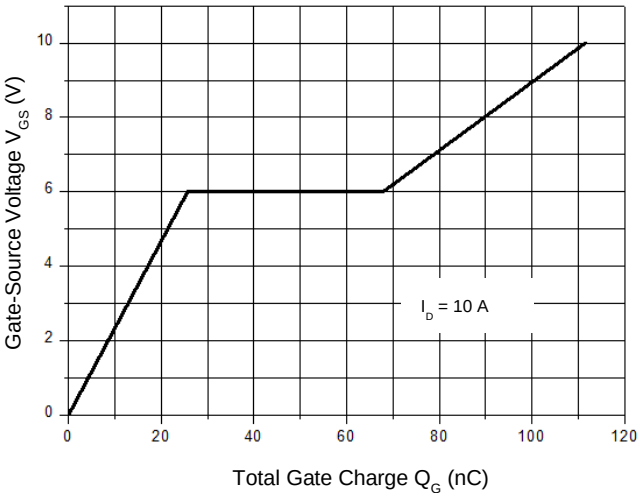


Figure 9 Maximum Safe Operating Area

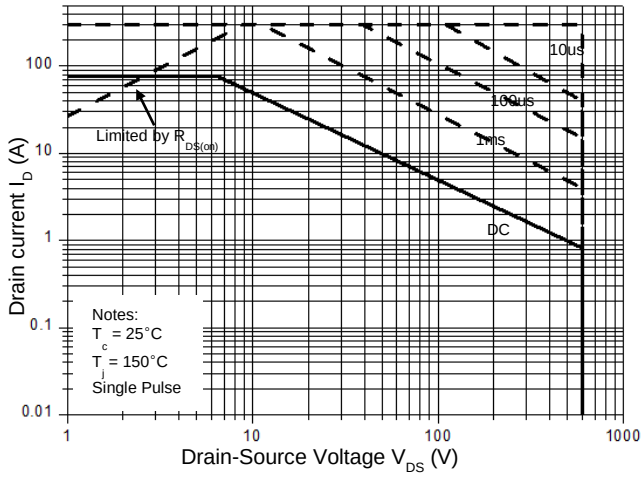
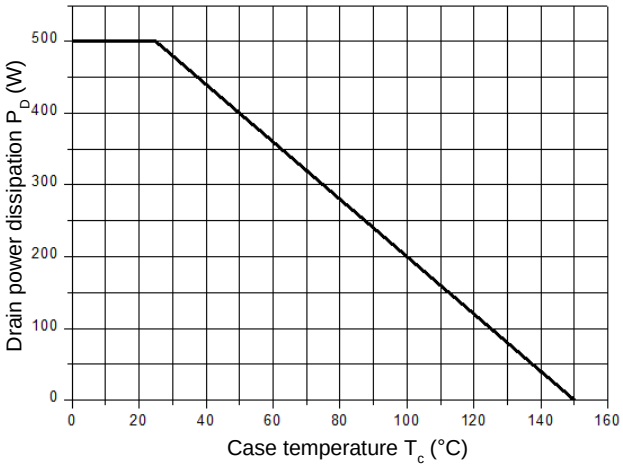
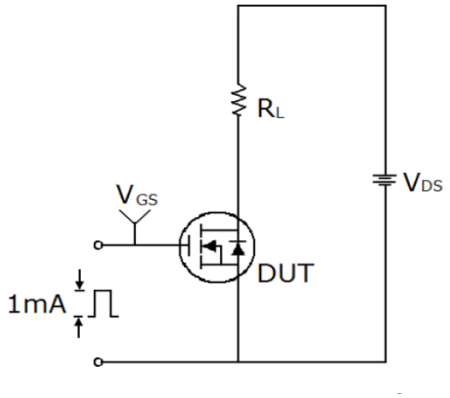
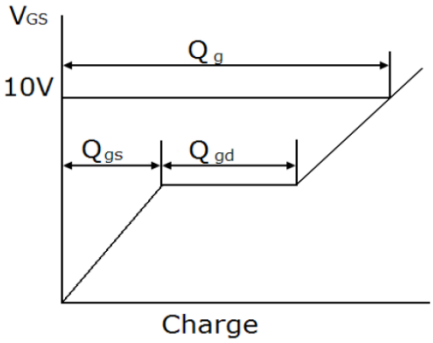


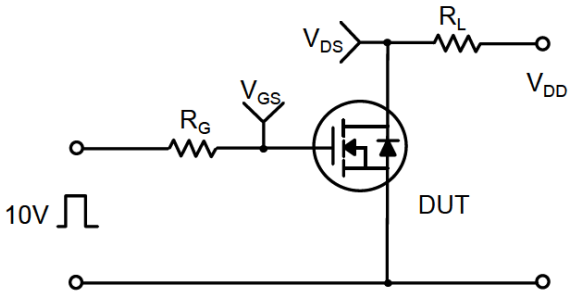
Figure 10 Power Dissipation vs. Temperature

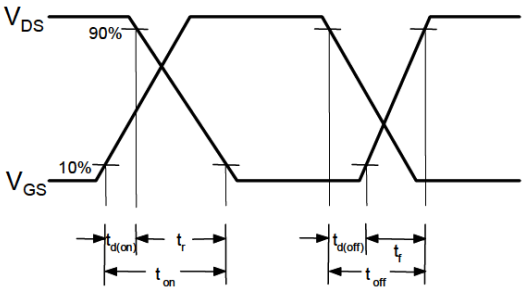


Gate Charge Test Circuit & Waveform

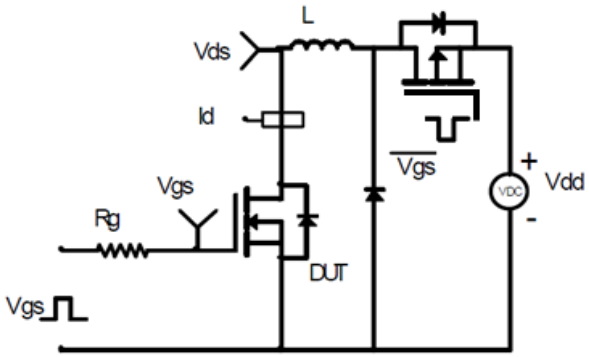


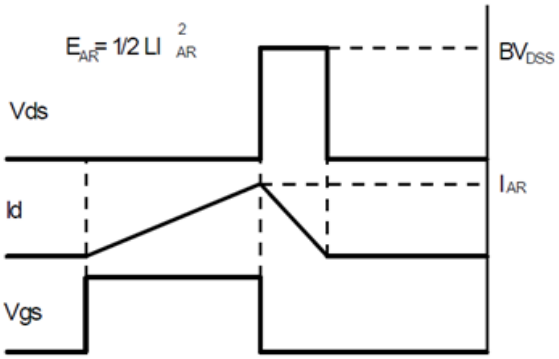




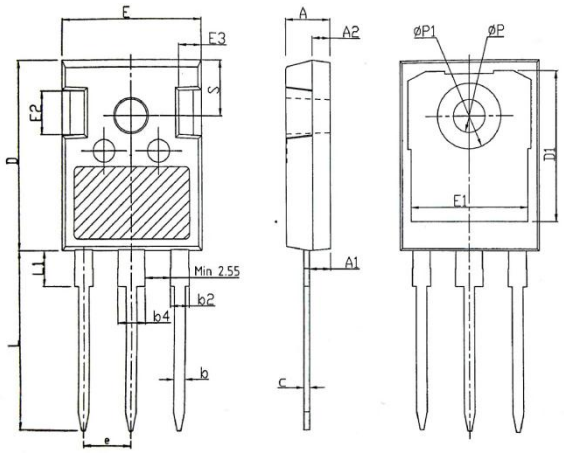


Unclamped Inductive Switching Test Circuit & Waveforms



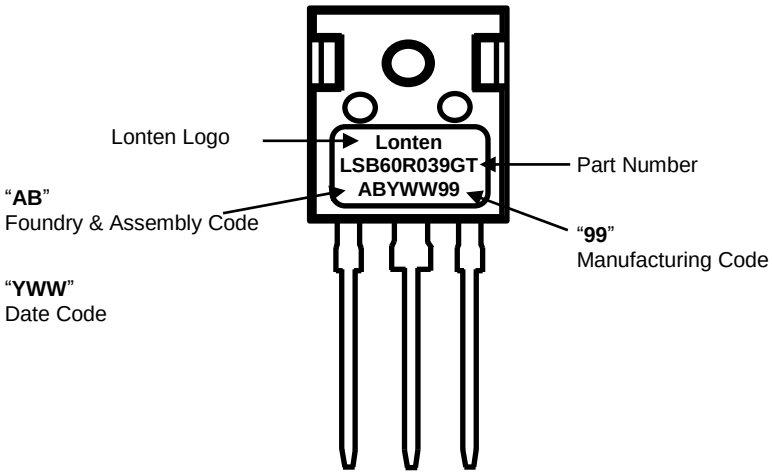


Mechanical Dimensions for TO-247



SYMBOL	mm		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.80	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e		5.44BSC	
L	19.82	19.92	20.22
L1	—	—	4.30
ØP	3.40	3.60	3.80
ØP1	—	—	7.30
S		6.15BSC	

TO-247 Part Marking Information



Disclaimer

The content specified herein is for the purpose of introducing LONTEN's products (hereinafter "Products"). The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

LONTEN does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of the Products or technical information described in this document.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). LONTEN shall bear no responsibility in any way for use of any of the Products for the above special purposes.

Although LONTEN endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a LONTEN product.

The content specified herein is subject to change for improvement without notice. When using a LONTEN product, be sure to obtain the latest specifications.

Apr. 2018 Revision 4.0